

### Main applications

Where transient overvoltage protection in ESD sensitive equipment is required, such as:

- Computers
- Printers
- Communication systems and cellular phones
- Video equipment

These devices are particularly adapted to the protection of symmetrical signals.

### Features

- 4 / 5 Unidirectional (ESDA6V1P6 / ESDA6V1-5P6) and Bidirectional (ESDA14V2BP6) Transil functions
- Breakdown voltage:  $V_{BR} = 6.1 \text{ V min. and } 14.2 \text{ V min.}$
- Low leakage current:   
 $< 500 \text{ nA}$  (ESDA6V1P6 / ESDA6V1-5P6)   
 $< 1 \mu\text{A}$  (ESDA14V2BP6)
- Very small PCB area  $< 2.6 \text{ mm}^2$

### Description

The ESDAxxxP6 are monolithic arrays designed to protect up to 5 lines against ESD transients.

These devices are ideal for situations where both reduced line capacitance and board space saving are required.

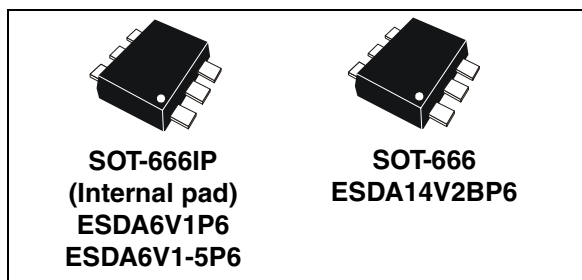
### Benefits

- High ESD protection level
- High integration
- Suitable for high density boards

### Complies with the following standards:

**IEC61000-4-2 level 4:** 15 kV (air discharge)   
 8 kV (contact discharge)

**MIL STD 883E-Method 3015-7: class3**   
 25 kV (Human Body Model)



### Order codes

Part Number	Marking
ESDA6V1P6	B
ESDA6V1-5P6	C
ESDA14V2BP6	A

Figure 1. ESDA6V1P6 functional diagram

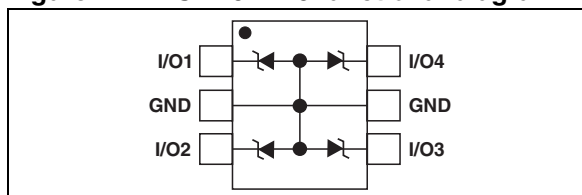


Figure 2. ESDA6V1-5P6 functional diagram

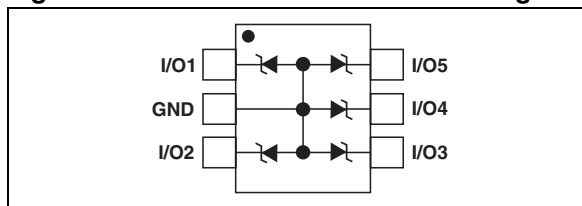
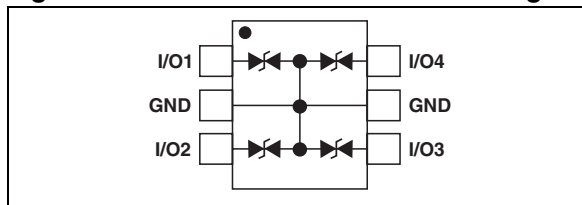


Figure 3. ESDA14V2BP6 functional diagram



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# 1 Characteristics

**Table 1. Absolute Maximum Ratings ( $T_{amb} = 25^{\circ}C$ )**

Symbol	Parameter	Value	Unit
$P_{PP}$	Peak pulse power (8/20 $\mu s$ ) <sup>(1)</sup>	ESDA6V1P6 / ESDA6V1-5P6	150
	$T_j$ initial = $T_{amb}$	ESDA14V2BP6	50
$T_j$	Junction temperature	150	$^{\circ}C$
$T_{stg}$	Storage temperature range	-55 to +150	$^{\circ}C$
$T_L$	Maximum lead temperature for soldering during 10 s at 5 mm for case	260	$^{\circ}C$
$T_{op}$	Operating temperature range	-40 to +150	$^{\circ}C$

1. for a surge greater than the maximum values, the diode will fail in short-circuit.

**Table 2. Electrical Characteristics ( $T_{amb} = 25^{\circ}C$ )**

Symbol	Parameter
$V_{RM}$	Stand-off voltage
$V_{BR}$	Breakdown voltage
$V_{CL}$	Clamping voltage
$I_{RM}$	Leakage current
$I_{PP}$	Peak pulse current
$\alpha T$	Voltage temperature coefficient
$V_F$	Forward voltage drop
C	Capacitance
$R_d$	Dynamic resistance

Part Numbers	$V_{BR}$			$I_{RM}$ @ $V_{RM}$		$R_d$ max.	$\alpha T$ typ.	C typ. @ 0V
	min.	max.	@ $I_R$	max.				
	V	V	mA	$\mu A$	V	$\Omega$	$10^{-4}/^{\circ}C$	pF
ESDA6V1P6	6.1	7.2	1	0.5	3	1.5	4	70
ESDA6V1-5P6								
ESDA14V2BP6	14.2	18	1	1	12	1.5	5.8	25
				0.1	3			

Figure 4. Peak power dissipation versus initial junction temperature

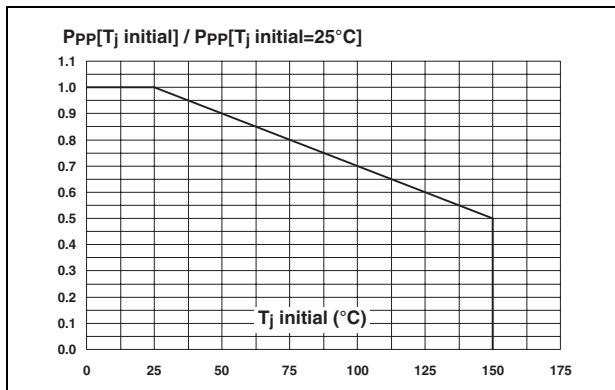


Figure 5. Peak pulse power versus exponential pulse duration ( $T_j \text{ initial} = 25^\circ\text{C}$ )

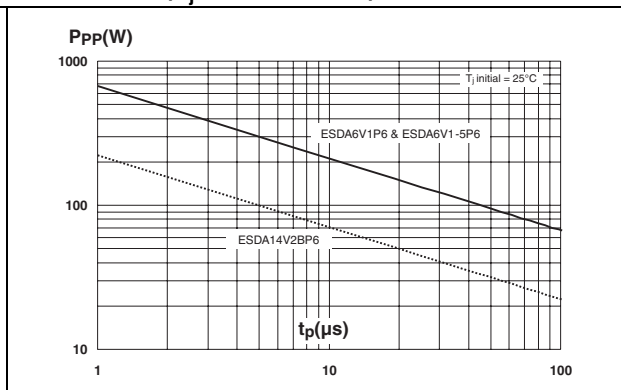


Figure 6. Clamping voltage versus peak pulse current ( $T_j \text{ initial} = 25^\circ\text{C}$ , rectangular waveform,  $t_p = 2.5 \mu\text{s}$ )

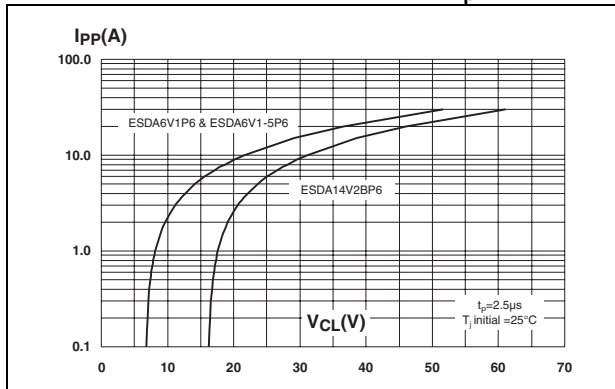


Figure 7. Junction capacitance versus reverse applied voltage (typical values)

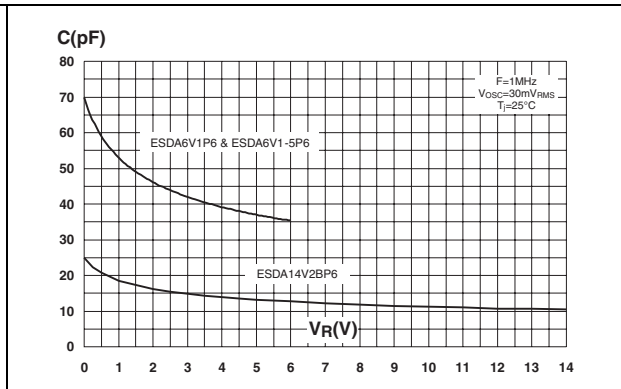


Figure 8. Relative variation of leakage current versus junction temperature (typical values)

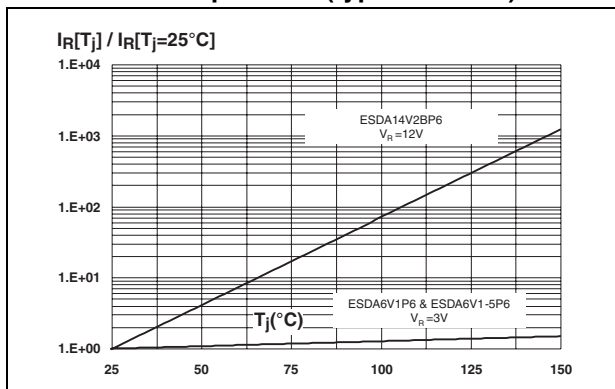
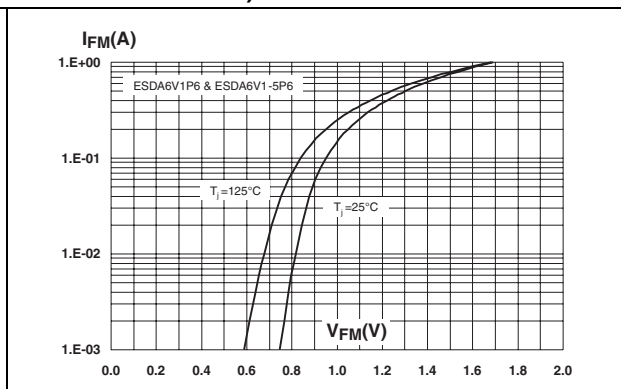
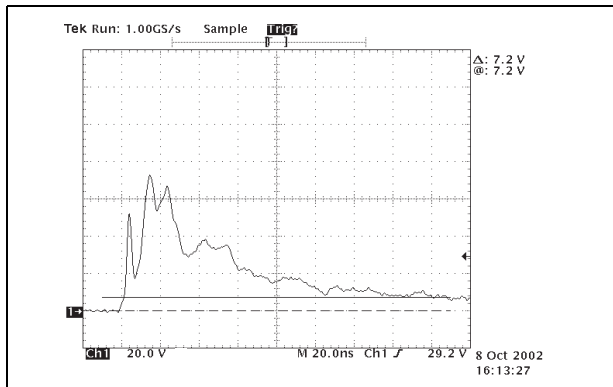


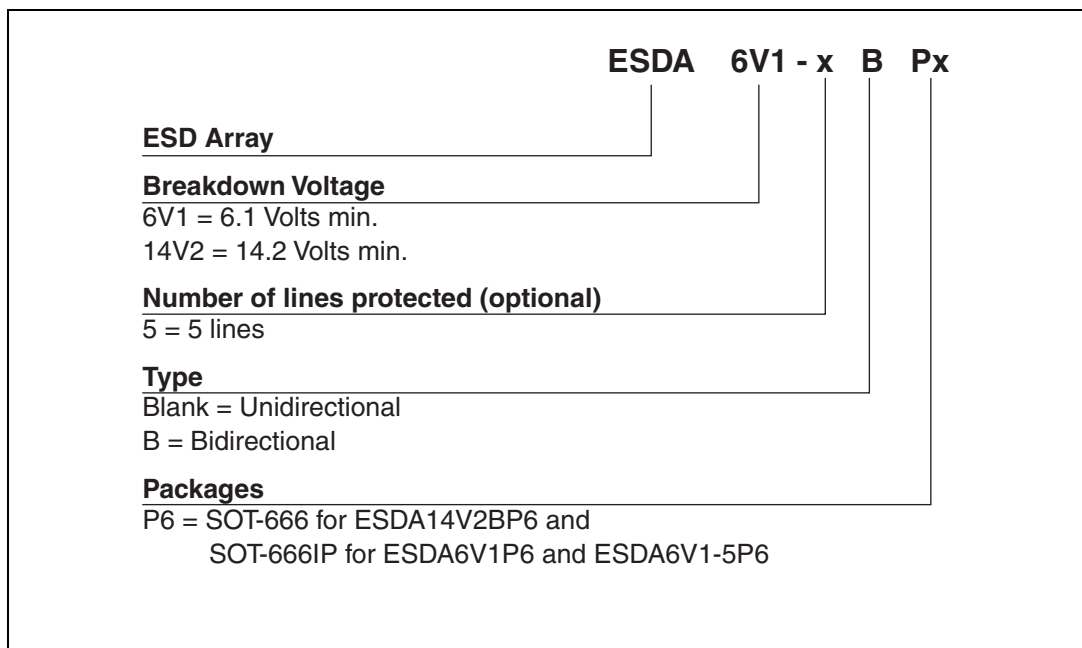
Figure 9. Peak forward voltage drop versus peak forward current (typical values)



**Figure 10. ESD response @  $V_{PP} = 15$  kV air discharge (ESDA6V1-5P6)**



## 2 Ordering information scheme

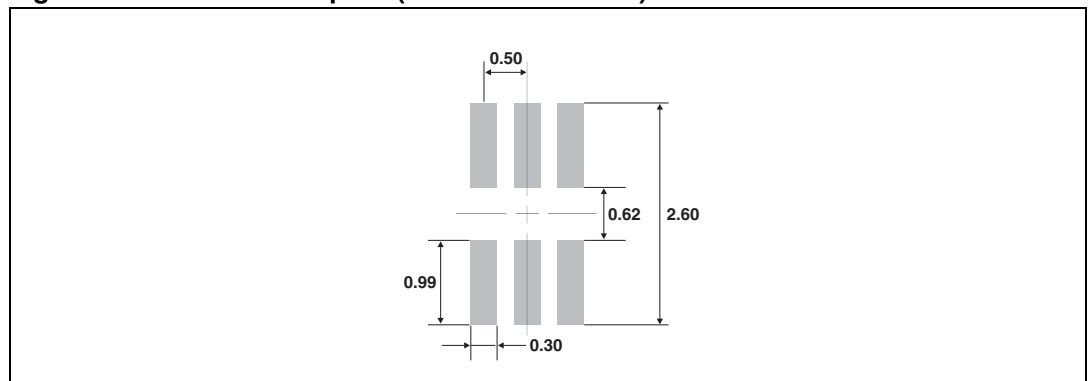


### 3 Package information

Table 3. SOT-666 Dimensions

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.45		0.60	0.018		0.024
A3	0.08		0.18	0.003		0.007
b	0.17		0.34	0.007		0.013
b1	0.19	0.27	0.34	0.007	0.011	0.013
D	1.50		1.70	0.059		0.067
E	1.50		1.70	0.059		0.067
E1	1.10		1.30	0.043		0.051
e		0.50			0.020	
L1		0.19			0.007	
L2	0.10		0.30	0.004		0.012
L3		0.10			0.004	

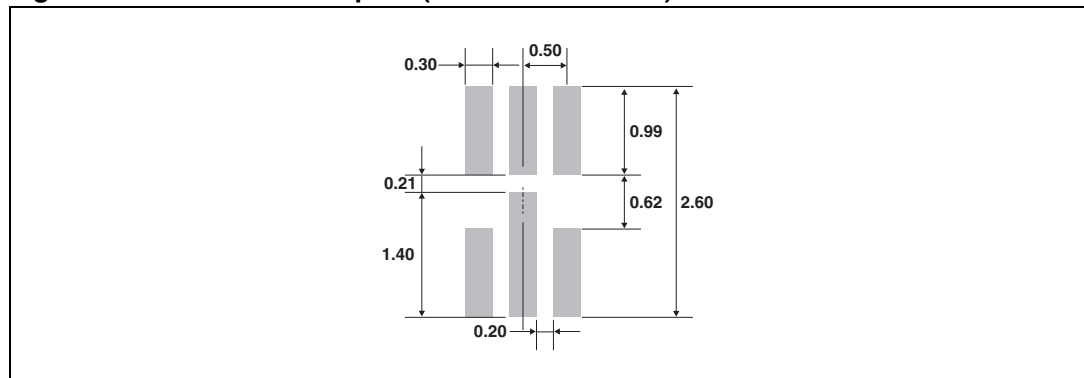
Figure 11. SOT-666 Footprint (dimensions in mm)



**Table 4. SOT-666IP Dimensions**

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.45		0.60	0.018		0.024
A3	0.08		0.18	0.003		0.007
b	0.17		0.34	0.007		0.013
b1	0.19	0.27	0.34	0.007	0.011	0.013
D	1.50		1.70	0.059		0.067
E	1.50		1.70	0.059		0.067
E1	1.10		1.30	0.043		0.051
e		0.50			0.020	
L1		0.19			0.007	
L2	0.10		0.30	0.004		0.012
L3		0.10			0.004	
L4		0.60			0.024	

**Figure 12. SOT-666IP Footprint (dimensions in mm)**



In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com).

## 4 Ordering information

Part Number	Marking	Package	Weight	Base qty	Delivery mode
ESDA6V1P6	B	SOT-666IP	2.9 mg	3000	Tape and reel
ESDA6V1-5P6	C				
ESDA14V2BP6	A	SOT-666			

## 5 Revision history

Date	Revision	Changes
07-Feb-2006	1	ESDA6V1P6, ESDA6V1-5P6 and ESDA14V2BP6: datasheets merged. ECOPACK statement added. Some curves combined.
26-Jun-2006	2	Reformatted to current standards. Modified package information to show both SOT-666 and SOT-666IP.

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